

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold

Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Product image



















Similar to illustration

High-temperature-resistant two-tier SCD-THR pin header for reflow soldering.

- It allows you to use two interfaces on only one surface and with only one step in the work flow.
- Outlet direction: 90° (recumbent)
- Connections at the same level and with access that is flush over the front board.
- Space for labelling and coding
- Packed in cardboard box.

Weidmüller's 3.81-mm-pitch (0.15 inch) plug-in connectors are compatible with the layouts of standard connectors and offer space for labelling and coding.

General ordering data

Туре	SCD-THR 3.81/04/180F 3.2SN BK BX
Order No.	<u>1031460000</u>
Version	PCB plug-in connector, male header, Flange, THT/ THR solder connection, 3.81 mm, No. of poles: 4, 180°, Solder pin length (I): 3.2 mm, tinned, black, Box
GTIN (EAN)	4032248760480
Qty.	50 pc(s).
Product data	IEC: 320 V / 17.5 A UL: 300 V / 10 A
Packaging	Вох



Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold

Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Technical data

Dimensions and weights

Width	18.01 mm	Width (inches)	0.709 inch
Height	25.1 mm	Height (inches)	0.988 inch
Height of lowest version	21.9 mm	Depth	22.7 mm
Depth (inches)	0.894 inch	Net weight	8.048 g

Environmental Product Compliance

REACH SVHC Lead 7439-92-1

System specifications

Product family	OMNIMATE Signal - series	Type of connection	
	BC/SC 3.81		Board connection
Mounting onto the PCB	THT/THR solder	Pitch in mm (P)	
	connection		3.81 mm
Pitch in inches (P)	0.15 inch	Outgoing elbow	180°
No. of poles	4	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin length tolerance	+0,02 / -0,02 mm
Tolerance of solder pin position	± 0.1 mm	Solder pin dimensions	d = 1.0 mm, Octagonal
Solder pin dimensions = d tolerance	0 / -0,03 mm	Solder eyelet hole diameter (D)	1.3 mm
Solder eyelet hole diameter tolerance	(D)+ 0,1 mm	Outside diameter of solder pad	2.1 mm
Template aperture diameter	1.9 mm	L1 in mm	3.81 mm
L1 in inches	0.15 inch	Number of rows	2
Pin series quantity		Touch-safe protection acc. to DIN VDE	
	2	57 106	Safe from finger touch
Touch-safe protection acc. to DIN VDE		Volume resistance	
0470	IP 20		$6.00~\text{m}\Omega$
Can be coded	Yes	Plugging cycles	25
Plugging force/pole, max.	8 N	Pulling force/pole, max.	5.5 N

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
CTI	≥ 175	Insulation strength	≥ 10 ⁸ Ω
Moisture Level (MSL)	1	UL 94 flammability rating	V-0
GWIT	930 °C	GWFI	960 °C
Contact material	Copper alloy	Contact surface	tinned
Storage temperature, min.	-25 °C	Storage temperature, max.	55 °C
Max. relative humidity during storage	80 %	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-25 °C
Temperature range, installation, max.	120 °C		



Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold

Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Technical data

Rated data acc. to IEC

tested acc. to standard		Rated current, min. no. of poles		
	IEC 60664-1, IEC 61984	(Tu=20°C)	17.5 A	
Rated current, max. no. of poles		Rated current, min. no. of poles		
(Tu=20°C)	9.4 A	(Tu=40°C)	17 A	
Rated current, max. no. of poles		Rated voltage for surge voltage class /		
(Tu=40°C)	8.1 A	pollution degree II/2	320 V	
Rated voltage for surge voltage class /		Rated voltage for surge voltage class /		
pollution degree III/2	160 V	pollution degree III/3	160 V	
Rated impulse voltage for surge voltage		Rated impulse voltage for surge voltage		
class/ pollution degree II/2	2.5 kV	class/ pollution degree III/2	2.5 kV	
Rated impulse voltage for surge voltage		Short-time withstand current resistance		
class/ contamination degree III/3	2.5 kV		3 x 1s with 76 A	

Rated data acc. to CSA

Rated voltage (Use group B / CSA)	300 V	Rated current (Use group B / CSA)	11 A

Rated data acc. to UL 1059

Institute (cURus)	30
	~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~
	U 2002

Certificate No. (cURus)

Rated voltage (Use group B / UL 1059)	300 V
Rated current (Use group B / UL 1059)	10 A
Reference to approval values	Specifications are

Rated voltage (Use group D / UL 1059) Rated current (Use group D / UL 1059) 10 A

Packing

Packaging	Box	VPE length	495 mm
VPE width	355 mm	VPE height	182 mm

see approval certificate.

Classifications

ETIM 4.0	EC002637	ETIM 5.0	EC002637
ETIM 6.0	EC002637	eClass 6.2	27-26-07-04
eClass 7.1	27-44-04-02	eClass 8.1	27-44-04-02
eClass 9.0	27-44-04-02	eClass 9.1	27-44-04-02

Rated current related to rated cross-section & min. No. of poles.
 Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
• P on drawing = pitch
Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.



Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold

Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Technical data

Approvals	c SN us III	
ROHS	Conform	

Approval/Certificate/Document	of
Conformity	Declaration of the Manufacturer
Brochure/Catalogue	FL DRIVES EN
	MB DEVICE MANUF. EN
	<u>FL DRIVES DE</u>
	CAT 2 PORTFOLIOGUIDE EN
	<u>FL BUILDING SAFETY EN</u>
	FL APPL LED LIGHTING EN
	FL INDUSTR.CONTROLS EN
	FL MACHINE SAFETY EN
	<u>FL HEATING ELECTR EN</u>
	<u>FL APPL_INVERTER EN</u>
	FL_BASE_STATION_EN
	<u>FL ELEVATOR EN</u>
	FL POWER SUPPLY EN
	FL 72H SAMPLE SER EN
	PO OMNIMATE EN
SMT white paper	Download Whitepaper



Weidmüller Interface GmbH & Co. KG

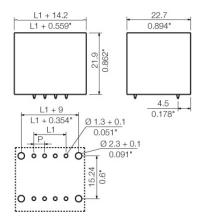
Klingenbergstraße 16 D-32758 Detmold

Germany Fon: +49 5231 14-0

Fax: +49 5231 14-292083 www.weidmueller.com

Drawings

Dimensional drawing





Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

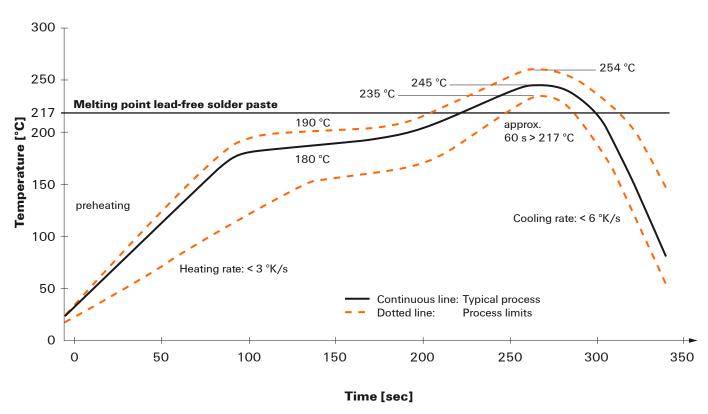


Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com



Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- · Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.